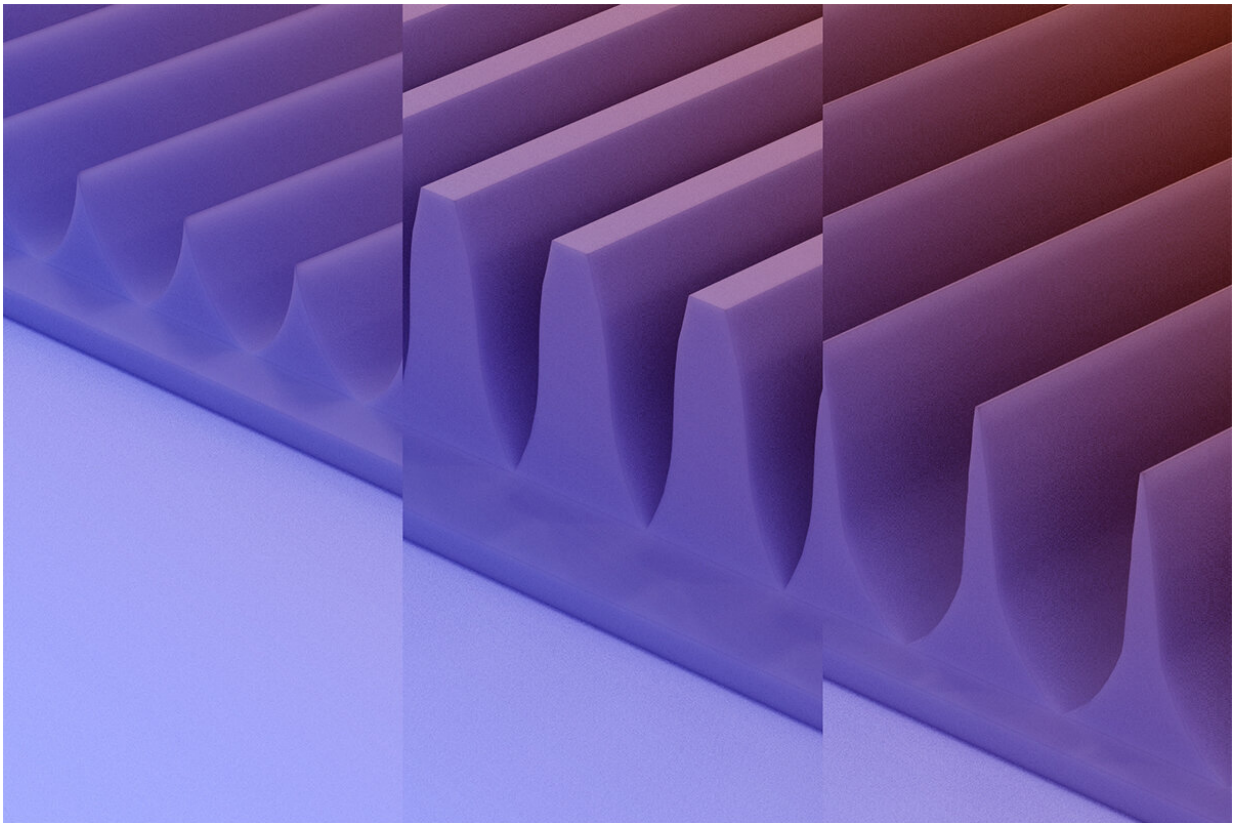


Search for new semiconductors heats up with gallium oxide

July 22 2019, by Lois Yoksouliau



An artist rendering of the MacEtch-produced fin array structures in a beta-gallium oxide semiconductor substrate from professor Xiuling Li's latest project. Credit: ACS Nano

University of Illinois electrical engineers have cleared another hurdle in

high-power semiconductor fabrication by adding the field's hottest material—beta-gallium oxide—to their arsenal. Beta-gallium oxide is readily available and promises to convert power faster and more efficiently than today's leading semiconductor materials—gallium nitride and silicon, the researchers said.

Their findings are published in the journal *ACS Nano*.

Flat transistors have become about as small as is physically possible, but researchers addressed this problem by going vertical. With a technique called metal-assisted [chemical etching](#)—or MacEtch—U. of I. engineers used a chemical solution to etch [semiconductor](#) into 3-D fin structures. The fins increase the [surface area](#) on a chip, allowing for more transistors or current, and can therefore handle more power while keeping the chip's footprint the same size.

Developed at the U. of I., the MacEtch method is superior to traditional "dry" etching techniques because it is far less damaging to delicate semiconductor surfaces, such as beta-gallium [oxide](#), researchers said.

"Gallium oxide has a wider energy gap in which electrons can move freely," said the study's lead author Xiuling Li, a professor of electrical and computer engineering. "This energy gap needs to be large for electronics with higher voltages and even low-voltage ones with fast switching frequencies, so we are very interested in this type of material for use in modern devices. However, it has a more complex [crystal structure](#) than pure silicon, making it difficult to control during the etching process."

Applying MacEtch to gallium oxide crystals could benefit the semiconductor industry, Li said, but the advancement is not without hurdles.

"Right now, the etching process is very slow," she said. "Because of the slow rate and the complex crystal structure of the material, the 3-D fins produced are not perfectly vertical, and vertical fins are ideal for efficient use of power."

In the new study, the beta-gallium oxide substrate produced triangular, trapezoidal and tapered fins, depending on the orientation of metal catalyst layout relative to the crystals. Although these shapes are not ideal, the researchers were surprised to find that they still do a better job conducting current than the flat, unetched beta-gallium oxide surfaces.

"We are not sure why this is the case, but we are starting to get some clues by performing atomic-level characterizations of the material," Li said. "The bottom line is that we have shown it is possible to use the MacEtch process to fabricate beta-gallium oxide, a potentially low-cost alternative to gallium nitride, with good interface quality."

Li said further research will need to address the slow etch rate, enable high performance beta-gallium oxide devices, and try to get around the problem of low thermal conductivity.

"Increasing the etch rate should improve the process's ability to form more vertical fins," she said. "This is because the process will happen so quickly that it will not have time to react to all of the differences in crystal orientations."

The low thermal conductivity issue is a deeper problem, she said. "High-power electronics produce a lot of heat, and device researchers are actively seeking thermal engineering solutions. While this is a wide-open aspect in the semiconductor field right now, 3-D structures like what we have demonstrated could help guide the heat out better in some device types."

More information: Hsien-Chih Huang et al, High Aspect Ratio β -Ga₂O₃ Fin Arrays with Low-Interface Charge Density by Inverse Metal-Assisted Chemical Etching, *ACS Nano* (2019). [DOI: 10.1021/acsnano.9b01709](https://doi.org/10.1021/acsnano.9b01709)

Provided by University of Illinois at Urbana-Champaign

Citation: Search for new semiconductors heats up with gallium oxide (2019, July 22) retrieved 2 May 2024 from <https://phys.org/news/2019-07-semiconductors-gallium-oxide.html>

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